

Development of High-density Signal Feedthroughs for Liquid Argon Calorimeters

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Workshop GranuLAr noble liquid Detectors

April 6 - 8, 2022

Outline

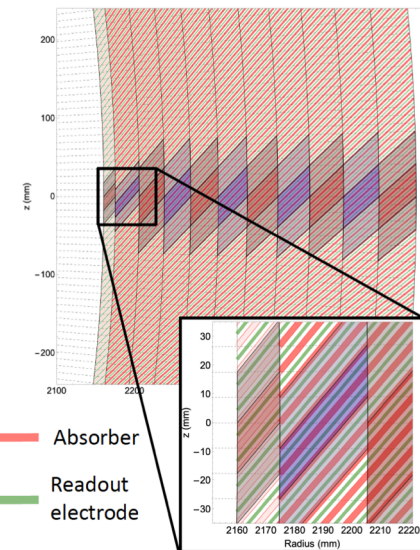
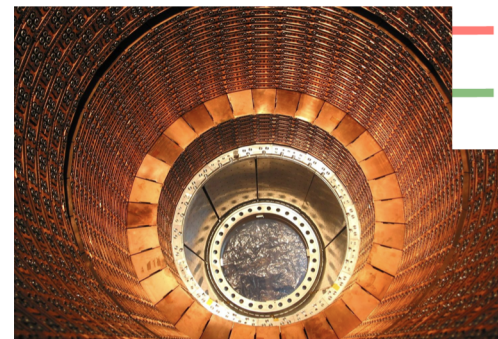
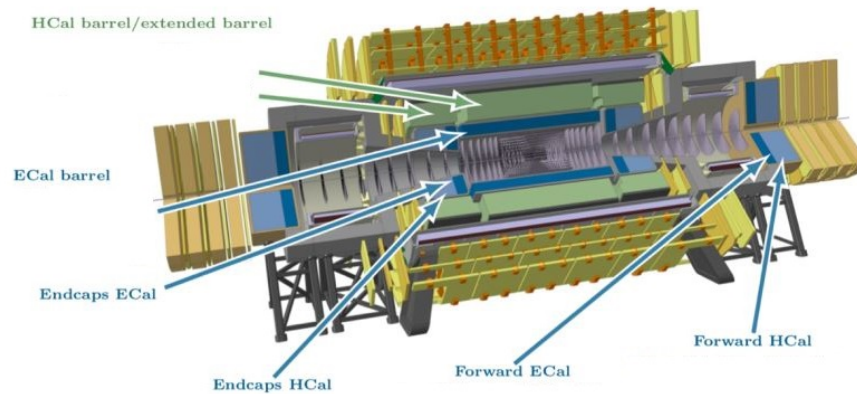
- Introduction
- High-density flanges
- Selection of components
- Experimental facility
- Experimental results
- Final design studies
- Conclusions

Introduction - Noble Liquid Calorimetry

- Noble liquid calorimetry is a well proven technology, successfully operated/operating in H1, NA48/62, ATLAS...
- Very promising candidate for future FCC experiments
- R&D direction: optimization for particle flow reconstruction on top of conventional calorimetry

Higher granularity
↓
Higher number of read-out channels
↓
Development of high-density signal feedthroughs

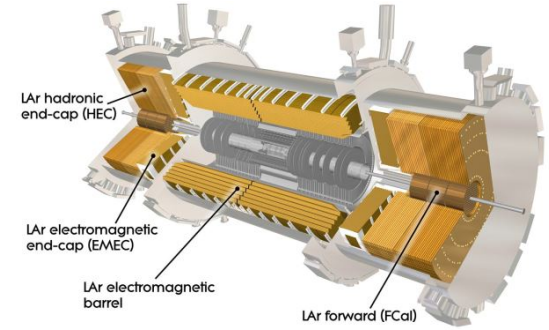
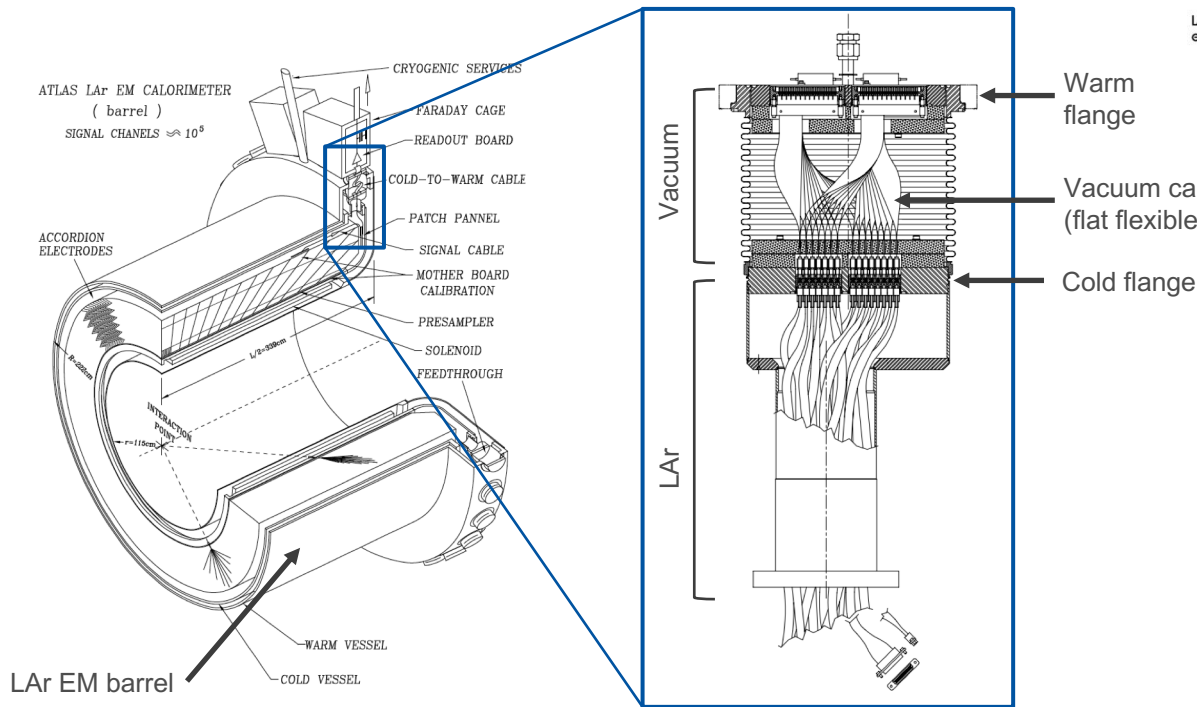
FCC-hh detector



From: M. Aleksa, Calorimeters for the FCC-hh (<https://arxiv.org/abs/1912.09962>)

Introduction - The feedthroughs of ATLAS

- Reference: signal feedthroughs of the ATLAS LAr EM calorimeters

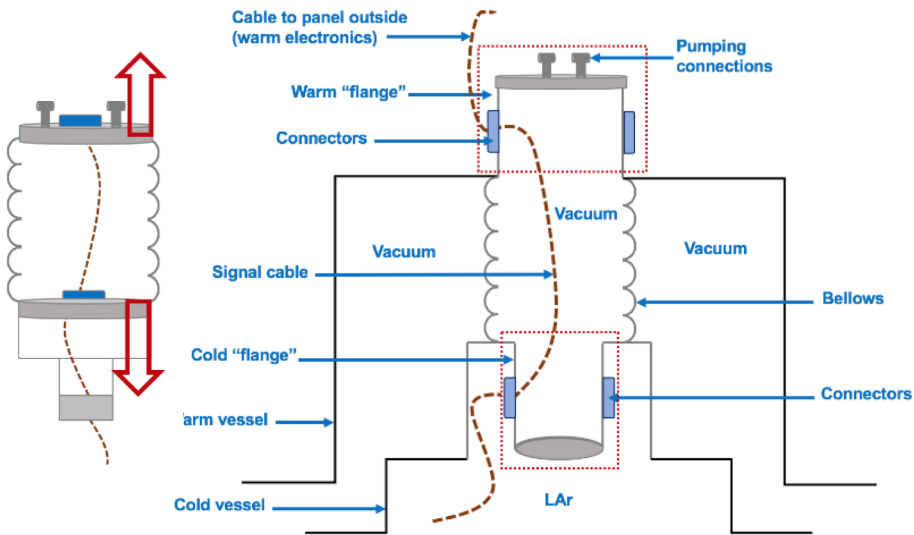


From: ATLAS LAr Unit, Liquid Argon Calorimeter – Technical Design Report
 From: D. Makowiecki et al., Signal feedthroughs for the ATLAS barrel and endcap calorimeters

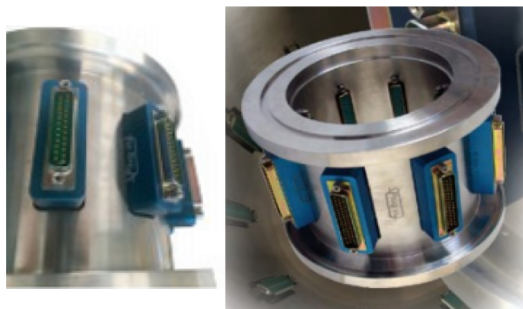
- Goal: 1920 wires/feedthrough (ATLAS) → ~20 000 wires/feedthrough (x10 more)

Introduction - 2 solutions considered

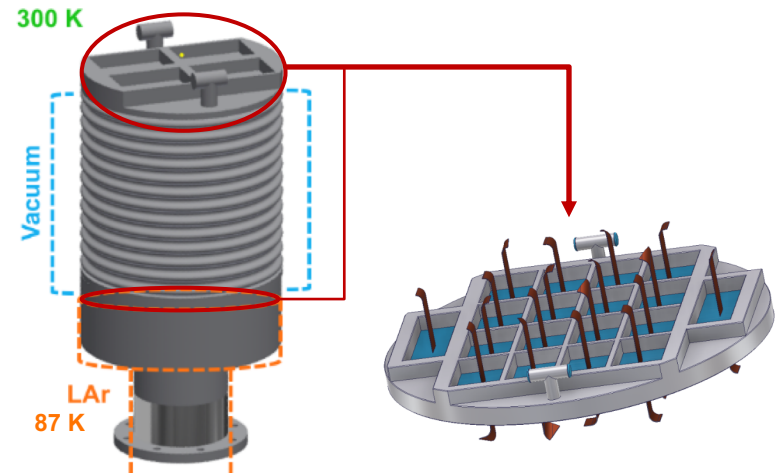
a) Large surface feedthroughs



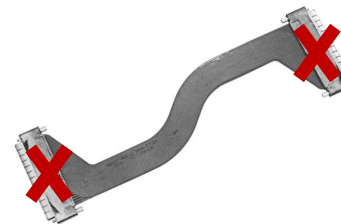
Higher number of connectors by using the available cylindrical surface



b) High-density flanges



Structures with high density of slits allowing the strip cables to pass → connectors-less solution

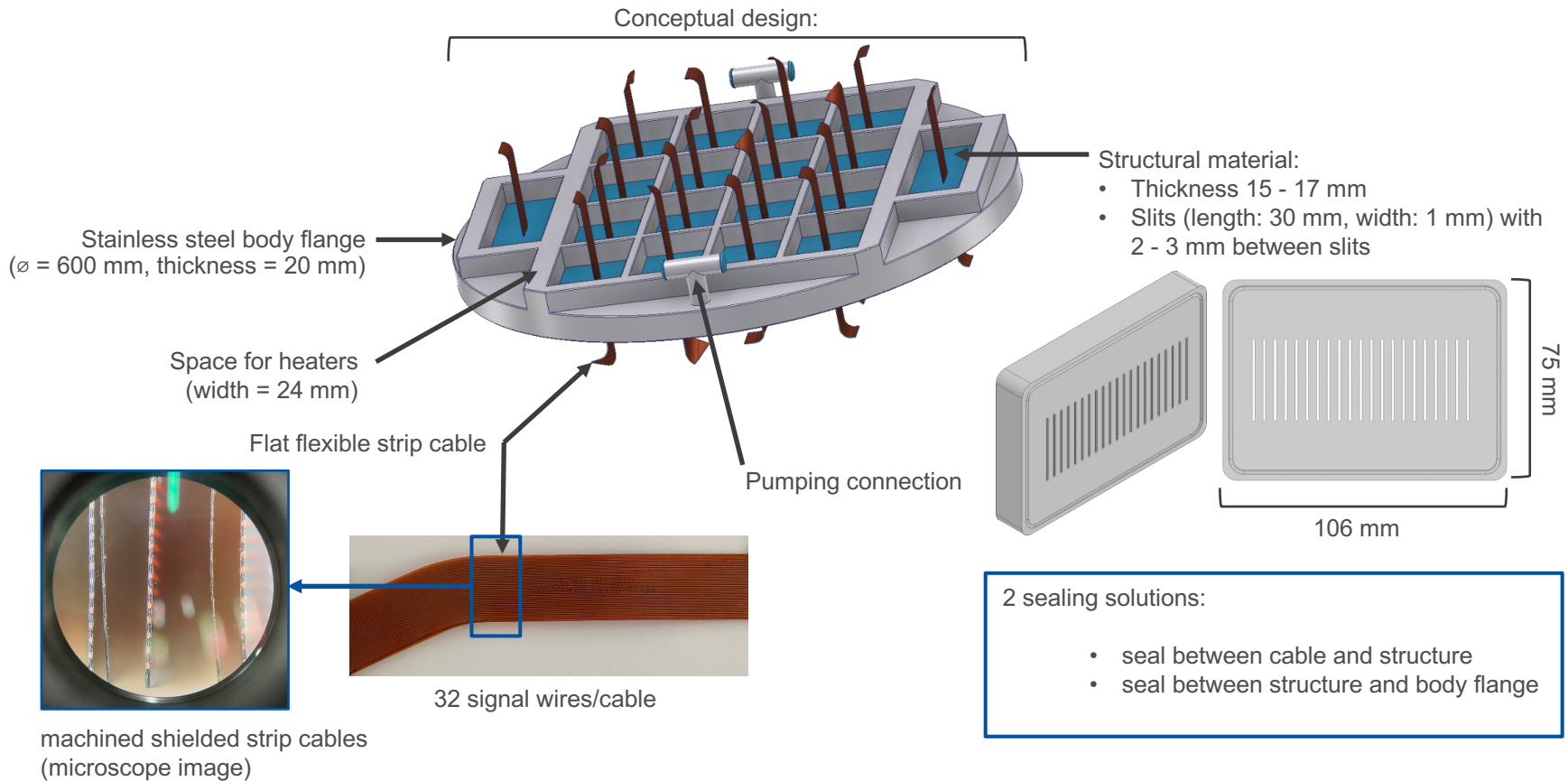


Connector x3 larger than strip cable

- Higher area dedicated to signal extraction
- Same design for warm and cold side

High-density flanges

- If the electronics sits outside of the cryostat (warm electronics), one needs high-density feedthroughs → high-density connector-less feedthroughs

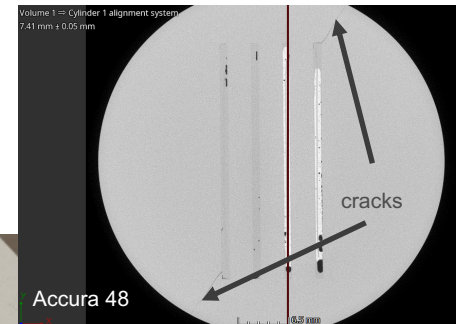


Selection of components

1. Structural material:

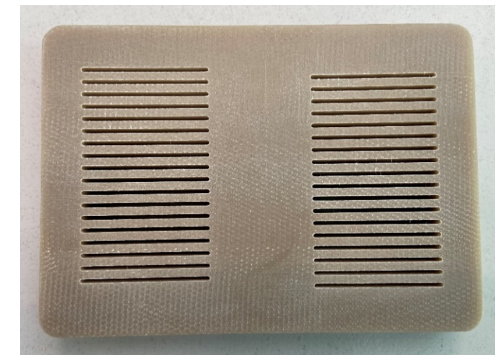
- Samples thermally shocked in LN₂ (77 K) + CT scans before and after
- Material candidates:

- **Accura 25** (3D-printed epoxy resin)
- Accura 48 (3D-printed epoxy resin) **X**
- **Silastic M** (silicone rubber – 3D-printed mold)
- **G10** (fiberglass laminate in epoxy resin)
- **G11** (fiberglass laminate in epoxy resin)
- **MY750** (araldite epoxy resin – 3D-printed mold)



▪ Main advantages:

- Fabrication processes (mechanical and financial viability)
- Lightness
- Low conductivity



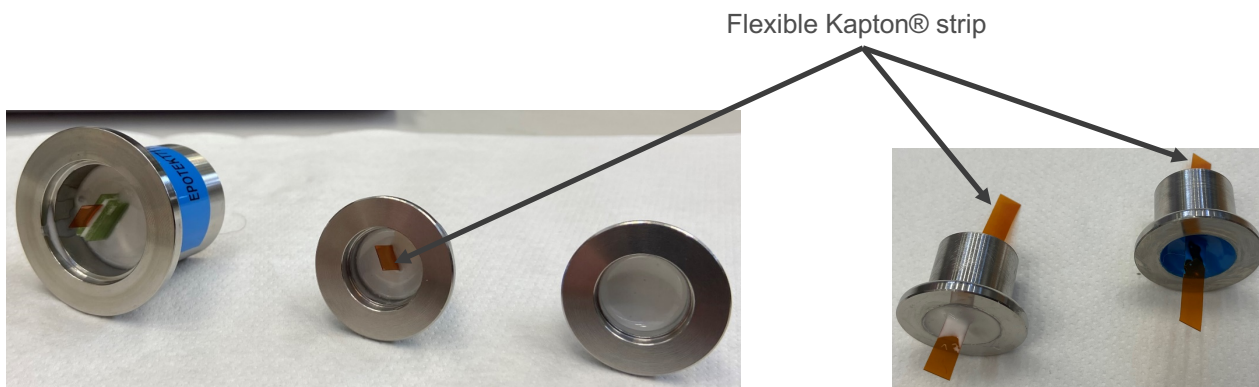
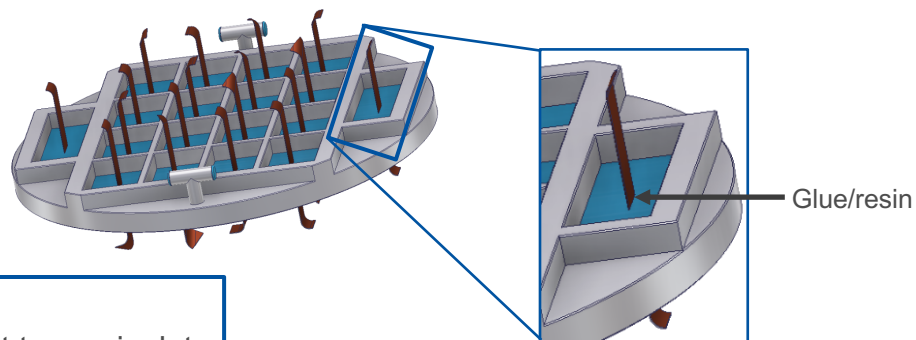
From CERN Polymer Laboratory

Selection of components

2. Seal between cable and structural material: glue/resin selection

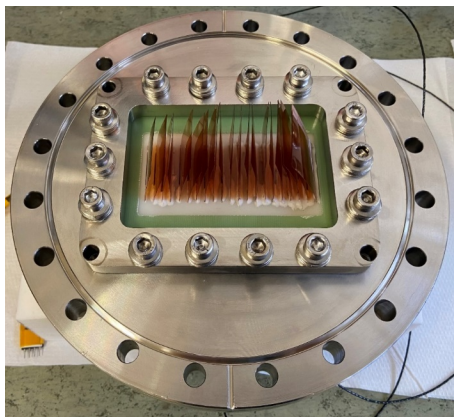
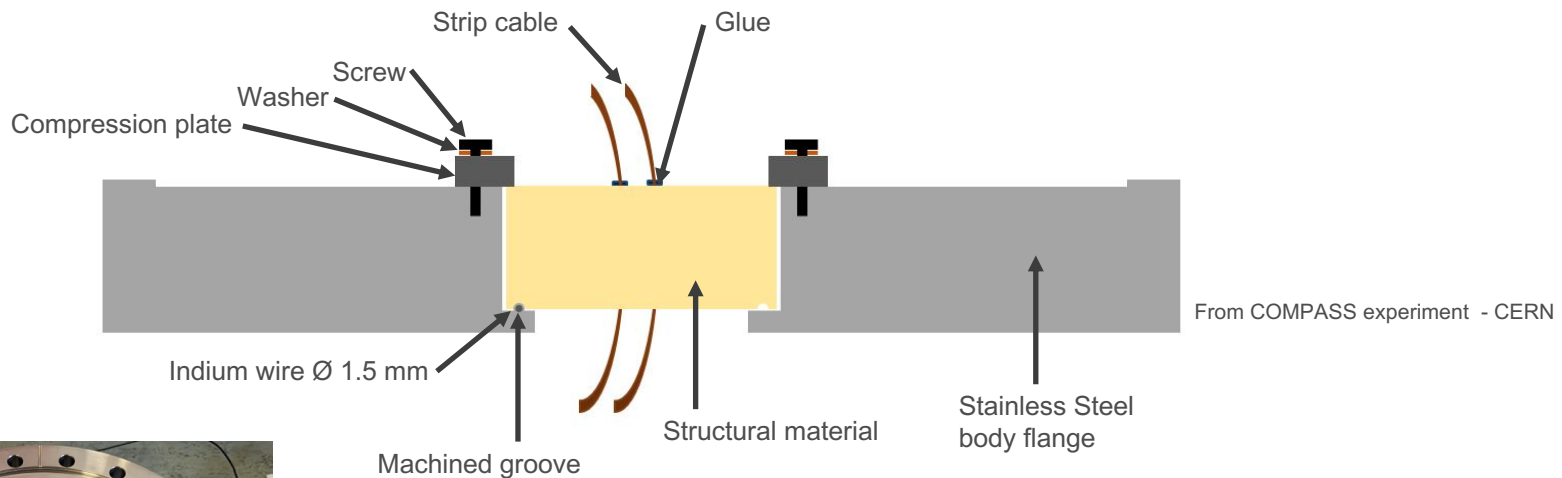
- Samples thermally shocked in LN₂ (77 K) several times and leak tested at room temperature
- Glue/resin candidates:

- DP 190
- Eccobond 286
- CAF-4
- RESINPRO
- **Epo-tek T7110** → easy to manipulate
- **Araldite 2011** → more viscous and difficult to manipulate
- Stycast

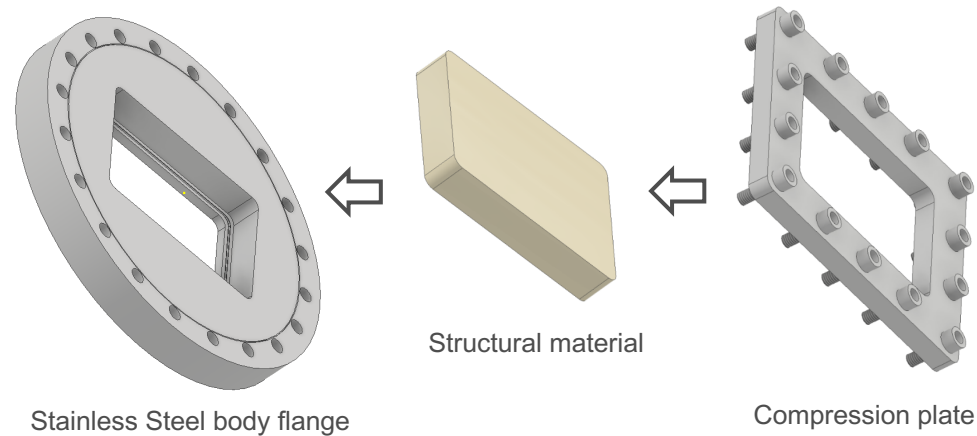


Selection of components

3. Seal between structural material and body flange: mechanical sealing solution



High-density flange sample to test



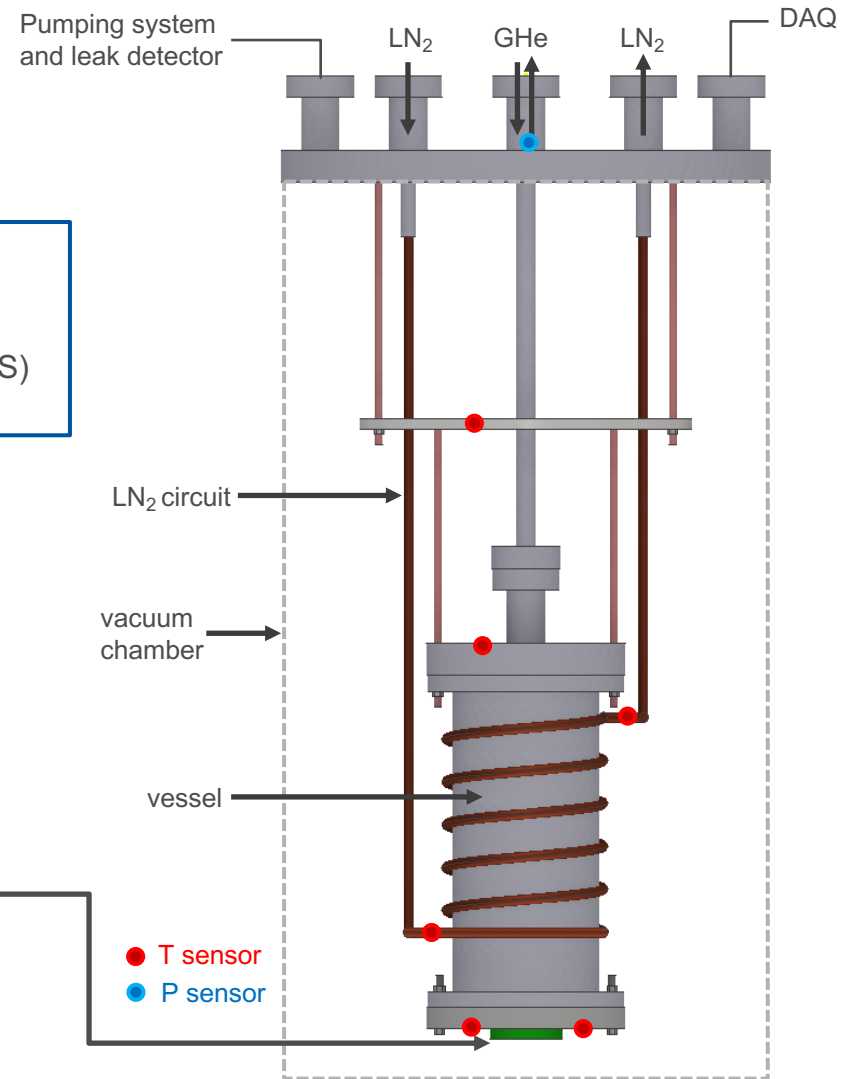
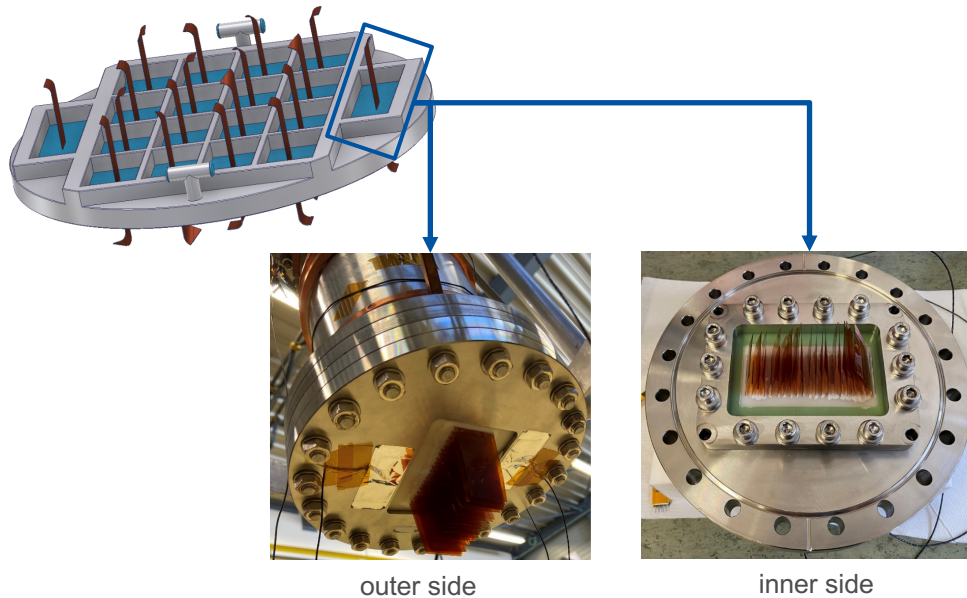
Experimental facility

- Experimental facility:
 - To perform pressure and leak test at room and low temperature

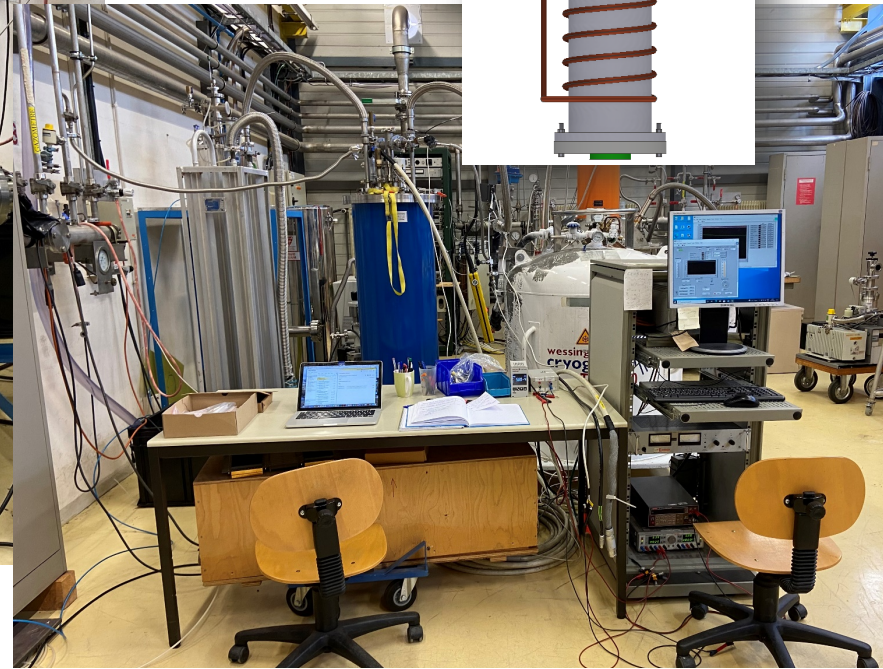
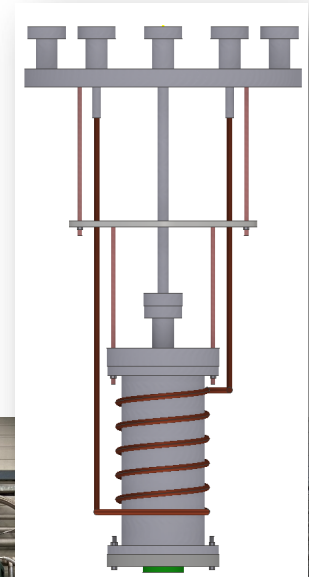
Test conditions:

- Temperature: **87 K** (operating conditions ATLAS)
- Pressure: **3.5 bar** (breaking vacuum accident ATLAS)
- Leak-tightness: $< 10^{-8}$ mbar.l/s

From: ATLAS LAr Unit, Liquid Argon Calorimeter – Technical Design Report



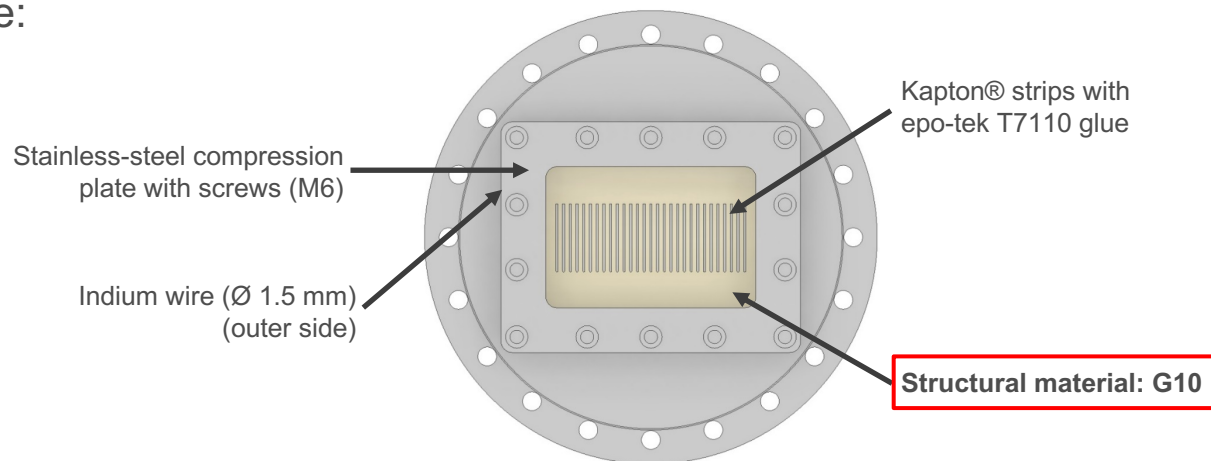
Experimental facility



Experimental results - example

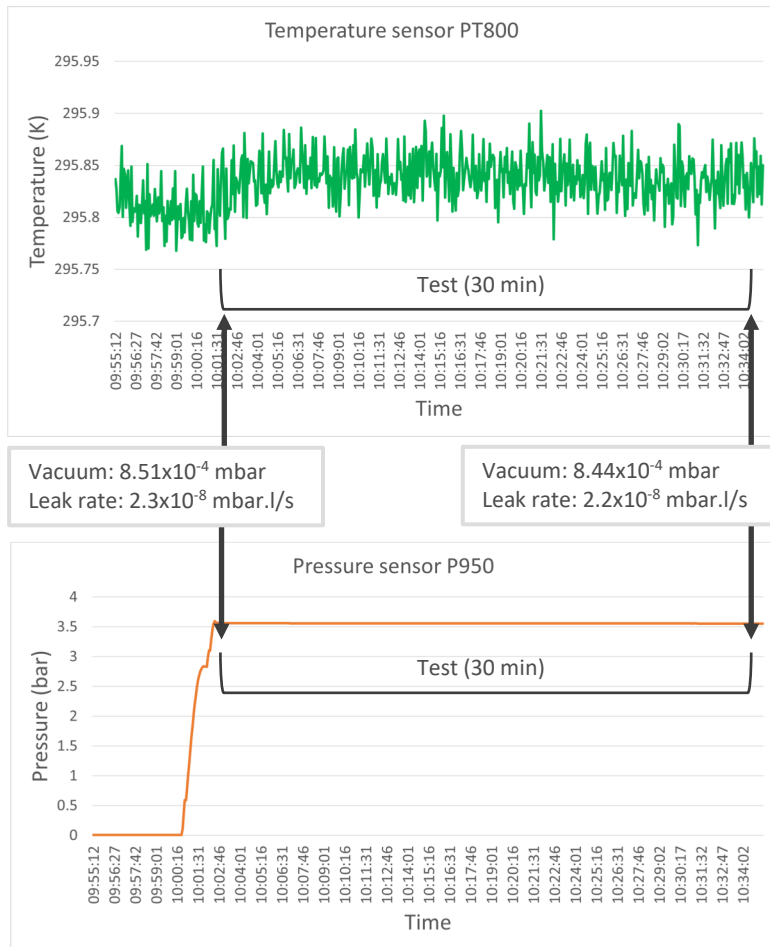
- Tests description:
 1. Leak and pressure test at room T° (30 min)
 2. Cooling down process (~7 hours)
 3. Leak and pressure test at low T° (30 min)
 4. Warming up process (1-2 days)

- Example:

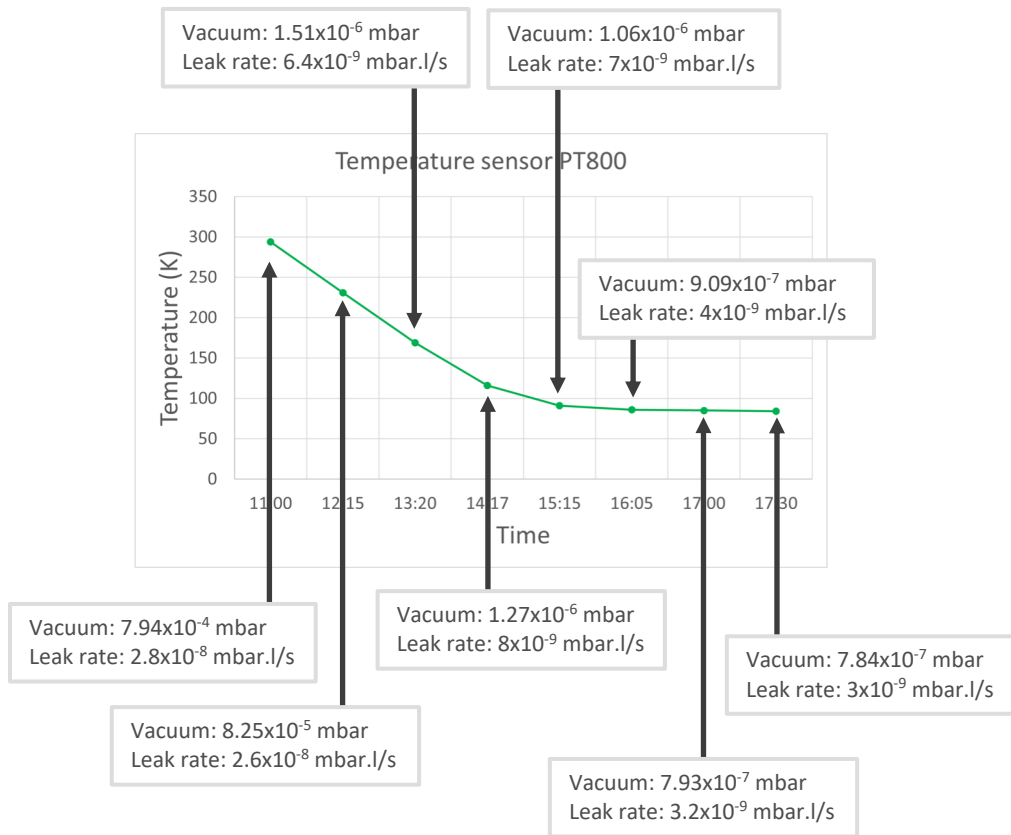


Experimental results - example

Step 1: Pressure and leak test at room T°

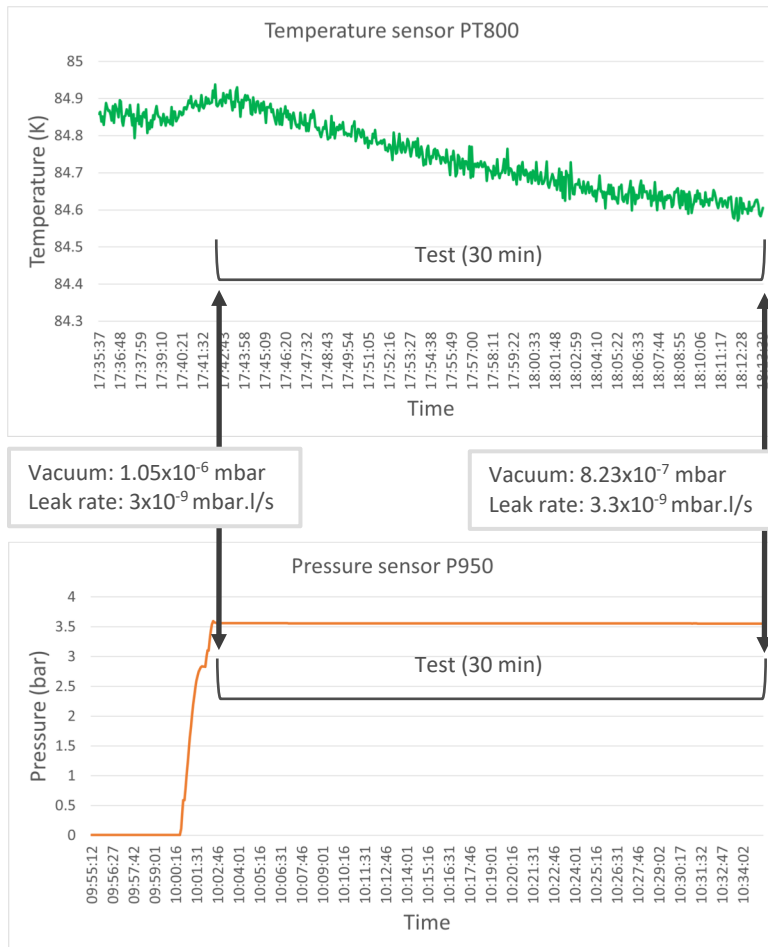


Step 2: Cooling down

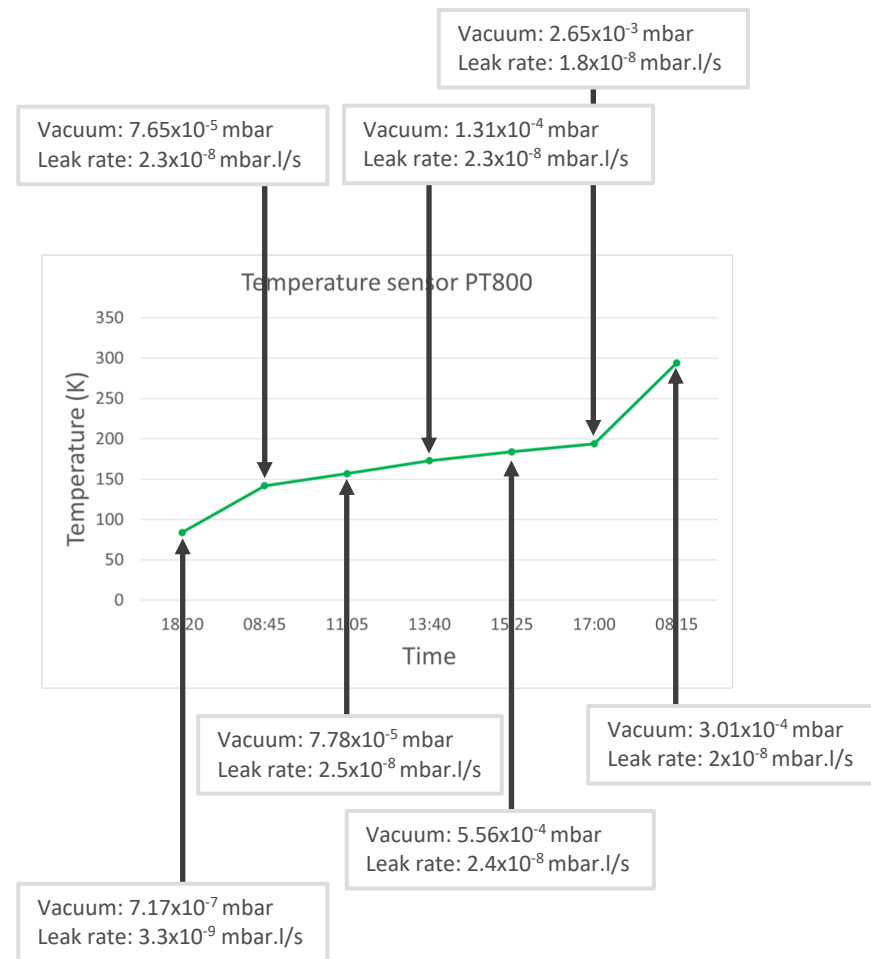


Experimental results - example

Step 3: Pressure and leak test at low T°



Step 4: Warming up



Experimental results - summary

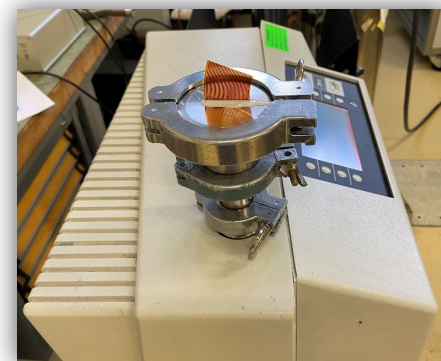
- Summary of samples tested:

Sample	Experimental results
MY750 + Kapton strips + glue epo-tek + indium seal	Leaks detected
Accura25 + Kapton strips + glue epo-tek + indium seal	Leaks detected
G10 + Kapton strips + glue epo-tek + indium seal	No leakage (2 cycles)
G11 + Kapton strips + glue epo-tek + indium seal	No leakage (2 cycles)



Sample A

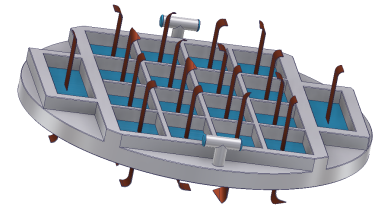
- Strip cable of from ATLAS also tested:
 - Thermally shocked in LN₂ (77 K) up to 3 times and leak tested in stainless steel circular samples:
Sample A (entire cable) → No leakage
Sample B (cut piece of cable) → No leakage



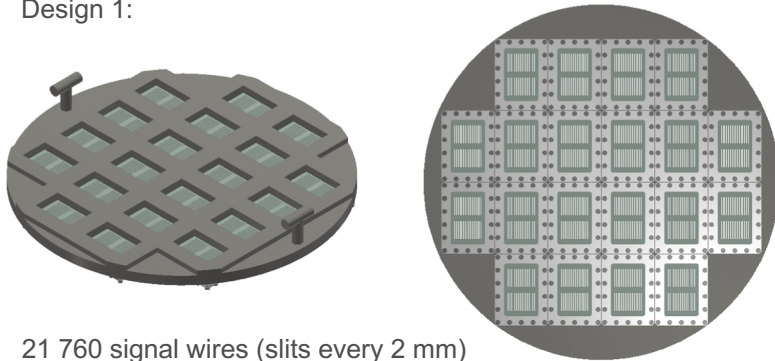
Sample B

Final design studies

- Up to 4 different flange designs studied (going from 16 000 to 30 000 signal wires/flange)

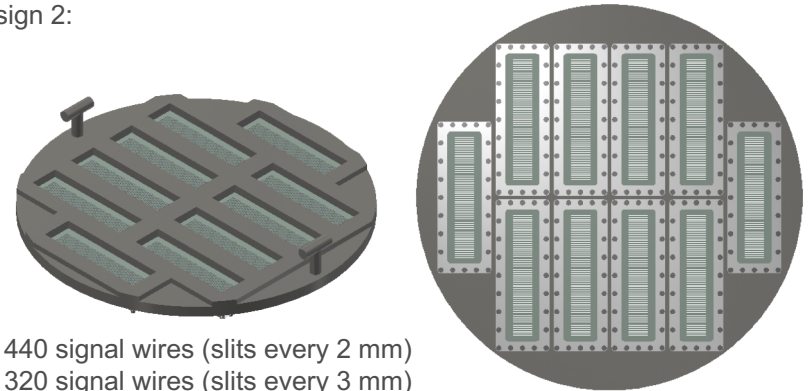


Design 1:



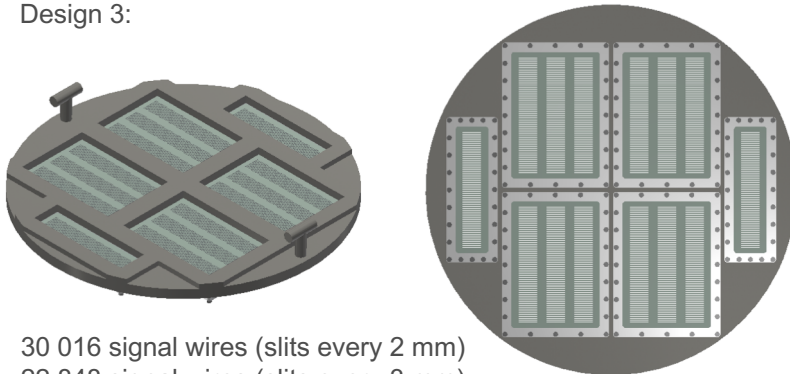
21 760 signal wires (slits every 2 mm)
16 640 signal wires (slits every 3 mm)

Design 2:



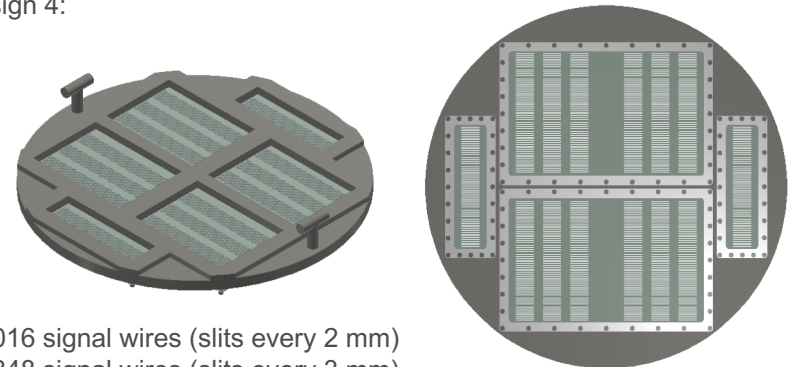
21 440 signal wires (slits every 2 mm)
16 320 signal wires (slits every 3 mm)

Design 3:



30 016 signal wires (slits every 2 mm)
22 848 signal wires (slits every 3 mm)

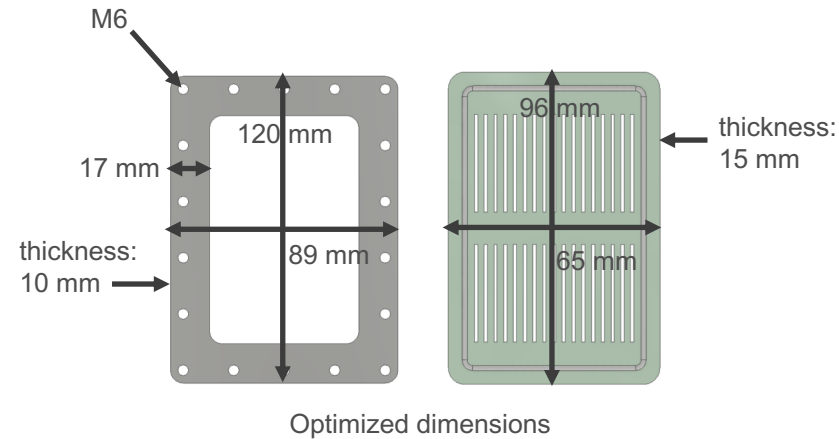
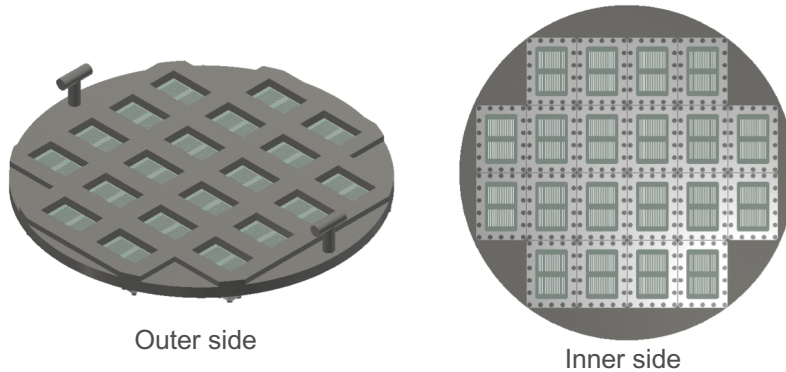
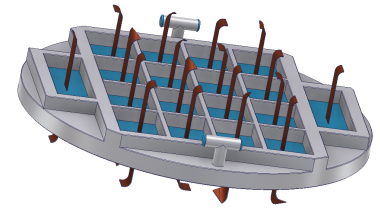
Design 4:



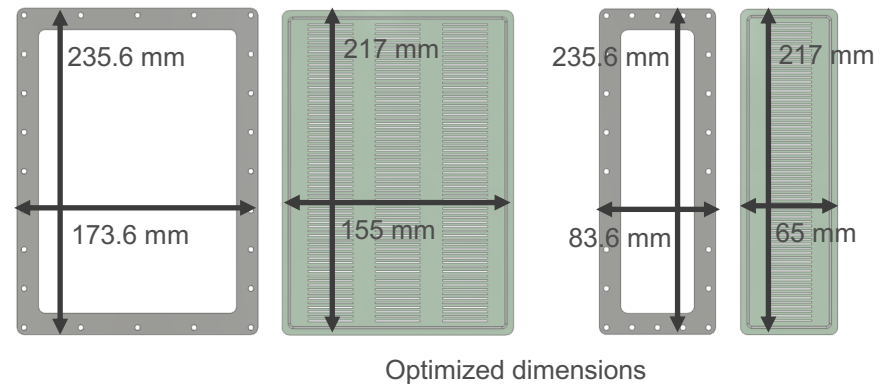
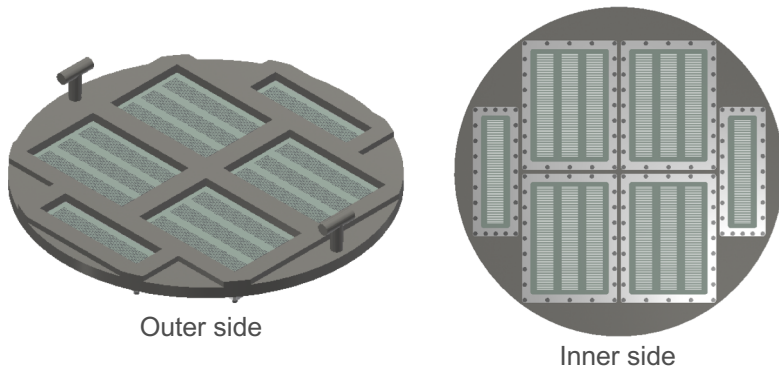
30 016 signal wires (slits every 2 mm)
22 848 signal wires (slits every 3 mm)

Final design studies

- 2 final designs selected:
 - Design 1: up to 21760 signal wires (2 mm)



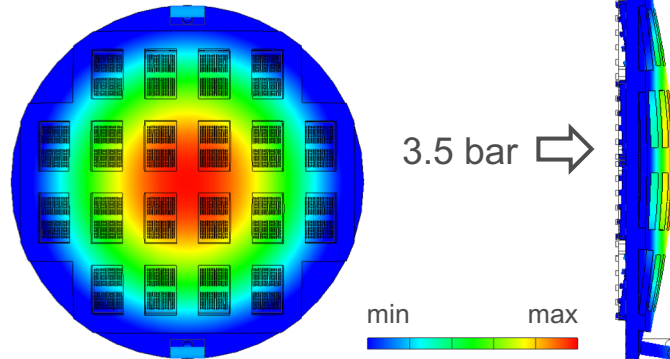
- Design 3: up to 30 016 signal wires (2 mm)



Final design studies

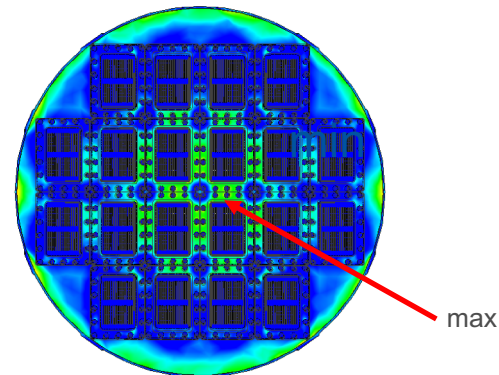
- Mechanical stress simulations:
 - Maximum deflection:

	295 K	77 K
Design 1	521.4 μm	474.8 μm
Design 3	760.3 μm	688.3 μm



- Maximum Von Mises stress:

	295 K	77 K
Design 1	94.72 MPa	94.54 MPa
Design 3	140.6 MPa	140.1 MPa



Max. deflection: 0.76 mm (ATLAS FT 0.68 mm with $\varnothing = 300$ mm)

Max. Von Mises Stress: 140 MPa (below yield and tensile strength of components)

From: O. Reinicke (TUB Berlin)

Conclusions

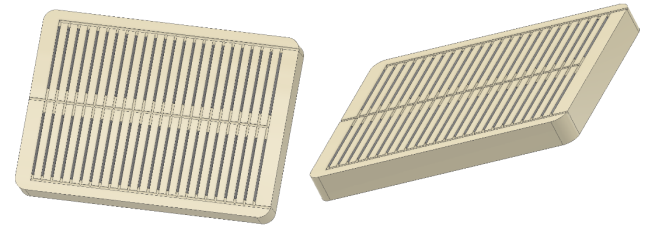
Summary:

- Main components have been studied and selected (structural material, glue and mechanical seal)
Rmk: also studies performed to analyse the failing samples (CTE measurements)
- Experimental setup has been designed and constructed to simulate extreme conditions in the LAr calorimeter (also used to test carbon fiber cryostat prototypes - internal collaboration)
- Experimental tests have shown the validation of the concept (G10, G11 but also Stainless-Steel) (tests at “extreme” conditions: cooling down times, < 87K, GHe)
- Mechanical simulations have shown the viability of different flange designs

Conclusions

Future steps:

- Establish standard protocols for the flange construction (surface treatments, gluing steps, capillary gluing, etc).
- Size optimization of different components (distance between slits, SS main grid size, etc.)
- Cable design and optimization (R&D ongoing on PCB electrodes design with noise and cross-talk mitigation – F. Briec)
- Other options:
 - High-density flange design with very thin connectors (~ 1.27 mm)
 - Other signal transfer technologies (increasing available surface, optical fibers, wireless solutions...)



Thank you for your attention!
Questions?





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